IPC ASSOCIATION CONNECTED ELECTRONICS INDUST	© Copyright 2005, IPC	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						formation	1	
Supplier Info	rmation														
Company name*		Company un	Company unique ID			Unique ID Authority					Response Date*				
nsemi				1								2025-09-09			
Contact Name			Title - Contact			I	Phone - Contact*				Email	Email - Contact*			
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Authorized Repro	esentative*	Title - Representative			I	Phone - Representative*				Email	Email - Representative*				
Product-Env-Ste	wards	Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com				
Reque	ester Item Number	Mfr Iten	tem Number Mfr Item Name				Effective Date	te Version Manufacturing Site		ite	Weight*		UOM	Unit Type	
		FDMS2572		FET 150V 47.0 mOhm MLP			2025-09-09	025-09-09 TH2			72.46895 mg		mg	Each	
Ianufacturin	g Proccess Informatio	on		<u> </u>								1			
Termin	Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 MS	TD-020 MSL Rating		Peak Process Body Temperature		e Max Time at	Peak Temper	ature	Number of Reflow Cycles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		Au) (no	CU Alloy 1		1		260		С	30	seco	onds	3		
Comments								<u> </u>		<u> </u>					
vel 1 - maximun	n time at peak temperature	during so	ldering is 10-3	30 seconds											
or more informa	ation regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.0142	mg	Supplier	Silicon (Si)	7440-21-3		1.0142	mg
Die Attach	0.1306	mg	Supplier	Silver (Ag)	7440-22-4		0.111	mg
			Supplier	Acrylic resins	Proprietary Data		0.0196	mg
Lead Frame	33.5385	mg	Supplier	Zinc (Zn)	7440-66-6		0.0436	mg
			Supplier	Iron (Fe)	7439-89-6		0.7882	mg
			Supplier	Copper (Cu)	7440-50-8		32.6799	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0268	mg
Mold Compound-Black	36.8372		Supplier	Carbon Black (C)	1333-86-4		0.1842	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		32.4167	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		2.3944	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.8419	mg
Plating	0.4686		Supplier	Silver (Ag)	7440-22-4		0.0073	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0167	mg
			В	Nickel (Ni)	7440-02-0		0.4352	mg
			Supplier	Gold (Au)	7440-57-5		0.0094	mg
Wire Bond - Cu	0.47985	mg	Supplier	Copper (Cu)	7440-50-8		0.4798	mg